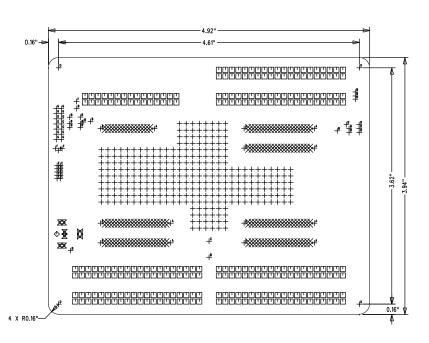
REV DESCRIPTION		APPD BY	DATE	
V1.0	Initial Release		08/01/15	
V3.0	Alpha Release		03/30/16	
V4.0	Production Release		11/05/16	

NOTES: UNLESS OTHERWISE SPECIFIED.

ALL SPECIFICATIONS REFERENCED SHALL BE OF THE LATEST REVISION.

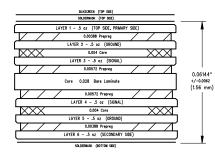
- 1. CONTROLLING DIMENSIONS AND SUPPLIED DATA ARE IN INCHES.
- DIMENSIONS AND TOLERANCES PER ASME Y14.5M.

 2. MATERIAL: COPPER CLAD 370HR or EQUIVALENT CORE PER IPC 4101.
 COPPER WEIGHT SHALL BE 0.5 OZ. PLATED TO 1 OZ. ON EXTERNAL LAYERS AND .5 OZ. ON INTERNAL LAYERS.
- 3. MINIMUM CONDUCTOR WIDTHS OF 0.0045" AND SPACINGS OF 0.005" SHALL BE HELD WITHIN +/- 20% OR .0025 MIN OF ORIGINAL DATA.
- 4. FINISH: 3-5 MICROINCHES IMMERSION GOLD OVER 100-200 MICROINCHES ELECTROLESS NICKEL.
- 5. APPLY LIQUID PHOTO IMAGEABLE SOLDER MASK OVER BARE COPPER, BOTH SIDES, PER IPC-SM-840, TYPE B, CLASS 2, COLOR: MATTE BLACK
- 6. WARP OR TWIST OF BOARD SHALL NOT EXCEED 0.75%.
- 7. PHOTOIMAGABLE SILKSCREEN COMPONENT SIDE USING WHITE, PERMANENT, ORGANIC, NON-CONDUCTIVE EPOXY INK. THERE SHALL BE NO SILKSCREEN ON ANY SOLDERABLE COMPONENT PADS.
- 8. REMOVE ALL BURRS AND BREAK SHARP EDGES 0.4 MAX.
- FINISHED BOARD SHALL MEET THE REQUIREMENTS OF ULT96 WITH A FLAMMABILITY RATING OF 94V-2 OR BETTER. VENDOR'S LOGO, DATE CODE AND LOT IDENTIFICATION SHALL BE LOCATED ON THE SECONDARY SIDE OF THE BOARD.
- 10. ALL BOARDS TO BE 100% ELECTRICALLY TESTED USING PROVIDED NETLIST. ALL NETS TO BE CHECKED FOR CONTINUITY AND SHORTS.
- 11. FABRICATE USING GERBER FILES SUPPLIED.



SIZE	QTY	SYM	PLATED	TOL
0.015	22	+	YES	+/-0.003
0.0252	270	X	YES	+/-0.003
0.028	10	+	YES	+/-0.003
0.03	3	+	YES	+/-0.003
0.03543	14	+	YES	+/-0.003
0.03937 x 0.09843	3	X	YES	+/-0.003
0.03937 x 0.11811	1	\bowtie	YES	+/-0.003
0.0437	270	□	YES	+/-0.003
0.045	296	+	YES	+/-0.003
0.055	14	+	NO	+/-0.003
0.06299	1	Φ	NO	+/-0.002
0.125	4	+	NO NO	+/-0.002
0.1252	1	+ ^c	YES	+/-0.003

6 LAYER STACK-UP



CONTROLLED	IMPEDANC

LAYER	TRACE WIDTH/SPACING	TYPE	IMPEDANCE
1	4.75 / 7.25 MIL	DIFFERENTIAL	100 OHMS +/-10%
1	6.00	SINGLE ENDED	50 OHMS +/-10%
3	4.50 / 7.50MIL	DIFFERENTIAL	100 OHMS +/-10×
3	5.75	SINGLE ENDED	50 OHMS +/-10%
4	4.50 / 7.50MIL	DIFFERENTIAL	100 OHMS +/-10×
4	5.75	SINGLE ENDED	50 OHMS +/-10%
6	4.75 / 7.25 MIL	DIFFERENTIAL	100 OHMS +/-10x
6	6.00	SINGLE ENDED	50 OHMS +/-10×

krtkl_6lyr_122315.pdf FOR COMPLETE STACK-UP DETAIL

THIRD ANGLE PROJECTION	DRAWING DESCRIPTION PCB Fabrication,			DOCUMENT NUMBER 15100501-05				REV. 4.0
UNLESS OTHERWISE SPECIFIED * INTERPRET DRAWING IAW ASME Y14.100-2000	Primary Side (TopLayer)		TITLE					
* DIMENSIONING & TOLERANCING IAW ASME Y14.5-1994 * PARENTHETICAL INFORMATION FOR REFERENCE ONLY	DESIGNER	D. BEANE	01AUG2015	[PCB, b	reakyBre	aky b	reako	ut board
DIMENSIONAL LIMITS APPLY BEFORE PROCESSES DIMENSIONS ARE IN INCHES	CHECK BY	B. HAMMOND	01AUG2015	1 ' ' '				
* TOLERANCES ARE: ANGLES .040 ** I PLACE DECIMAL .031	Q. A. BY	J. WEATHERBEE	01AUG2015	SHEET		SIZE	SCALE	
2 PLACE DECIMAL .010	Copyright 2016 krtkl inc.			1 1 of 1	ן ט		1:1	
* SURFACE FINISH * REMOVE ALL BURRS AND SHARP EDGES .010 RAD MAX. * CONCENTRICITY MACHINED DIA: .002 FIM * MACHINED TOOL MISMATCH .002 MAX.	Made available under a Creative Commons Attribution ShareAlike 4.0 International License. To view a copy of this license please visit http://creativecommons.org/licenses/by-so/4.0/		krtk	d	35	5	Street, Suite 301A San Francisco, CA (415) 857–4857 www.krtkl.com	

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